

## Epitaxial growth of bismuth oxyhalides thin films with mist CVD at atmospheric pressure

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Bismuth oxyhalides (BiOX, X = Cl, Br, I) are a series of layered tenary compounds with excellent photoenergy conversion applications, promising for photocatalysis and photovoltaics [1–2]. While the indirect bandgaps of 1.8, 2.6, 3.2 eV for X = Cl, Br, I, respectively, enable to harvest light from visible to ultraviolet region, the layered structure prevent efficient recombination of photo-excited electron and hole pairs [1]. In order to extract the full potential of these compounds, it is necessary to investigate quantitatively fundamental properties such as bandgap, optical absorption, and photoconductivity, by using single crystals. However, sufficiently large single crystals of BiOX have not been available so far. In this study, we developed facile growth route for epitaxial thin films of BiOX.

Bismuth oxyhalide epitaxial thin films were grown with mist chemical vapor deposition under atmospheric pressure, suitable for volatile elements such as bismuth [3]. N, N-dimethylformamide solution of corresponding Bi $X_3$  was nebulized into microscale mists and transferred by N<sub>2</sub> gas onto SrTiO<sub>3</sub> (001) single crystal substrates heated at 250 – 450 °C. N<sub>2</sub> and O<sub>2</sub> gases were used for diluting the mist during the deposition of BiOCl and the other BiOX, respectively.

X-ray diffraction showed successful growth of BiOX(001) epitaxial thin films at optimum temperateure for each composition (Fig.1). Full width at half maximum of rocking curves around 003 peaks was less than 0.1° for all the BiOX, indicating good crystallinity (Fig. 2). The film morphology was highly dependent on the growth temperature, and the flat surface with step terrace structure was observed for each film at the optimum growth temperature (Fig. 3). Lower growth temperatures resulted in partial coverage of the films, while higher growth temperatures resulted in rough surface accompanied by degraded crystallinity.



Reference: [1] Y. Yang *et al.*, *Adv. Colloid Interface Sci.* **254**, 76 (2018). [2] R. Hoye *et al.*, *Adv. Mater.* **29**, 1702176 (2017). [3] Z. Sun *et al.*, *Cryst. Growth Des.* **19**, 7170 (2019).